

# **Qualification Test Plan**

AVR800-XIA



Product	H/W	System	Testing
Manager	Leader	Engineer	Engineer
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Date 2022 Dec.



Version History			
Document Release	Date	Change Item	Remarks
V1.0	12/20/2022	Preliminary release	

	System Configuration
Motherboard	Supermicro X10SDV-16C-TP8F
CPU	Intel® Xeon D-2183IT (2.2Ghz, 100W, 22MB)
PCH	Intel Skylake D
RAM1	Samsung DDR4 2400 64GB
RAM2	Samsung DDR4 2400 64GB
RAM3	Samsung DDR4 2400 64GB
RAM4	Samsung DDR4 2400 64GB
GPU	Nvidia Tesla T4 16GB GDDR6 CUDA Cores 2560
SATA 1	2.5" U.2 NVMe 2TB SSD
SATA 2	2x 2.5" 8TB SSD
LAN 1	Intel® 10 Gigabit Ethernet
LAN 2	Intel® 10 Gigabit Ethernet
POWER	DC-DC 18V to 36V (300W Max) MIL-STD-461
Dimension	405(D) x 316 (W) x 154 (H) mm
Weight	15Kg(33.06lbs)
Chassis	Aluminum Alloy, Corrosion Resistant
Finish	Anodic aluminum oxide
Cooling	Natural Passive convection/Conduction with IP65 Active Fans
Ingress Protection	IP65

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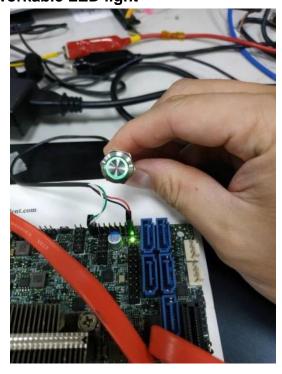
#### 1 I/O FUNCTIONAL TEST

Power Button & LED



#### **Test Method:**

- Connect the POWER BUTTON & power LED,
- Testing the motherboard after pressing the power button.
- Make sure the workable LED light

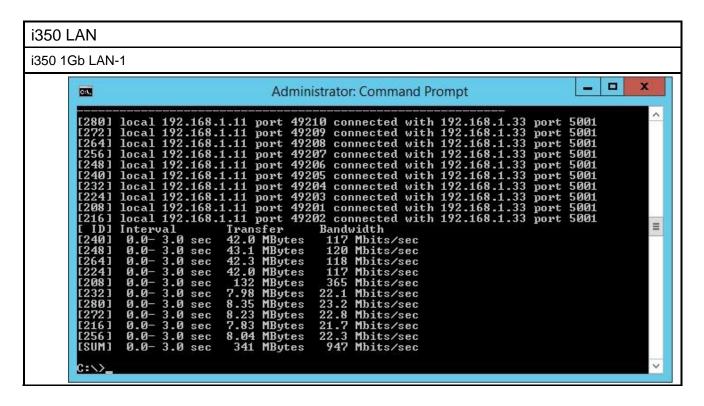


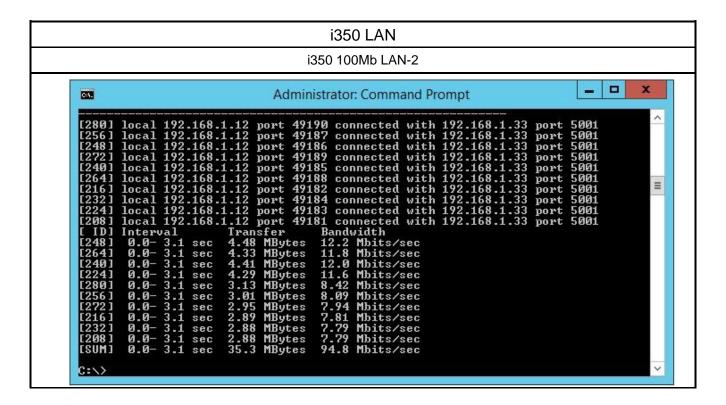
**X1 (10GbE LAN)** 



#### **Test Method:**

Check the LAN MAC ADDRESS on the MB, LAN SPEED and make sure that you can connect to the Internet





X2 (VGA)



#### **Test Method:**

Connect the VGA cable and make sure the screen will be displayed and the color is normal. functional.



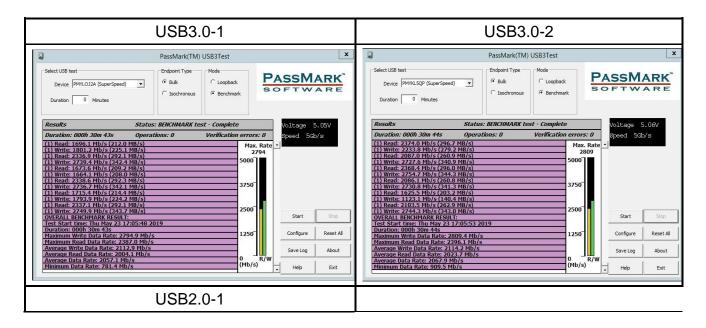
X3 (USB)

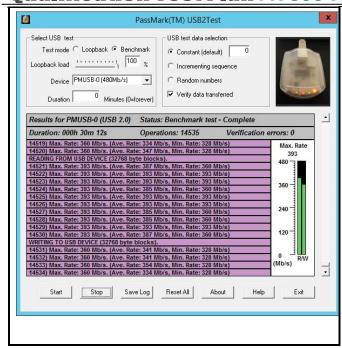


#### **Test Method:**

Check if we can detect the USB,2xpin header & real connector x2 with USB DEVICE

Loopback Plugs for USB 3.0 &USB2.0					
Software	Comment / (unit) connector Read / Write (Mb/s) Result Note				
	PassMark USB3.0 test	USB3.0-1	2004/2112		
PassMark Software	plug	USB3.0-2	2023/2114		
Passivialik Sultware	PassMark USB2.0 test	USB2.0-1	202/260 (Mb/a)		
	plug	USB2.U-1	393/360 (Mb/s)		





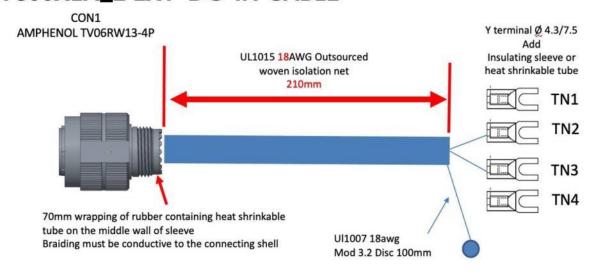
#### 2 AV800-X1A D38999 CONNECTOR

**INDEX** 

- 1. X1 EXT LAN AMPHENOL TV06RW-13-35P
- 2. X2 EXT VGA AMPHENOL TV06RW-13-98P
- 3. X3 EXT USB AMPHENOL TV06RW-13-35P
- 4. X4 EXT DC-IN AMPHENOL TV06RW13-4P



#### AV800X1A\_2 EXT-DC-IN CABLE





	CON1	
黄	Α	TN1
黄	В	TN2
黑	С	TN3
黑	D	TN4
綠	Shell	0端

#### AV800X1A\_4 EXT-LAN CABLE

CAT6 SFTP CABLE 2100mm

70mm wrapping of rubber containing heat shrinkable tube on the middle wall of sleeve Braiding must be conductive to the connecting shell

T568B

CON3

RJ45 Female

T568B

CON<sub>2</sub>

RJ45 Female

#### CON1 AMPHENOL TV06RW-13-35P



CON1	CON2		CON1	CON3	
1	1	WHITE / ORANGE	8	1	WHITE / ORANGE
2	2	ORANG	9	2	ORANG
3	3	WHITE / GREEN	10	3	WHITE / GREEN
4	6	GREEN	11	6	GREEN
5	4	WHITE / BLUE	12	4	WHITE / BLUE
6	5	BLUE	13	5	BLUE
15	7	WHITE / BROWN	19	7	WHITE / BROWN
16	8	BROWN	20	8	BROWN
7	SHELL	BLACK	14	SHELL	BLACK
17	SHELL	BLACK	21	SHELL	BLACK
18	SHELL	BLACK	22	SHELL	BLACK

### **AV800X1A\_6 EXT-VGA CABLE**

CON2 DSUB-15PIN Male Pin



VGA CABLE 2100mm

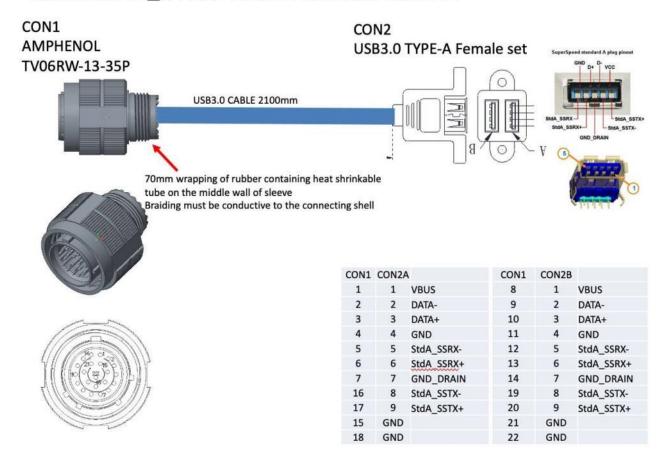
70mm wrapping of rubber containing heat shrinkable tube on the middle wall of sleeve Braiding must be conductive to the connecting shell

#### CON1 AMPHENOL TV06RW-13-98P



CON1	CON2	
Α	1	RED
В	2	GREEN
С	3	BLUE
D	5	GND
E	9	5V
F	11	Reserved
G	12	SDA
Н	13	H-Sync
J	14	V-Sync
K	15	SCL

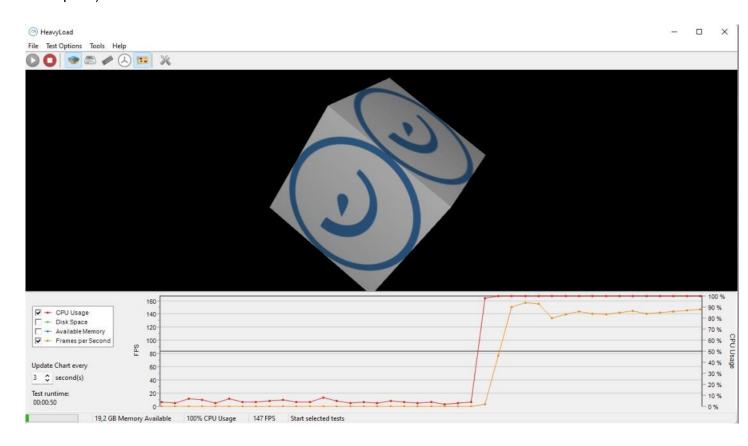
### AV800X1A\_8 EXT-DUAL USB3.0 CABLE



#### 3 STRESS CPU/GPU TEST

HeavyLoad is intended to stress all resources of a PC (CPU, GPU, RAM, hard disk, network, operating system etc.) in order to test if it will run reliably under heavy load. This is useful for assessing important file or database servers before using them productively, or simply to ensure your new PC will not overheat or crash when used intensively.

The program also allows testing the behavior of systems under fading system resources (memory, disk space).



#### Stress CPU

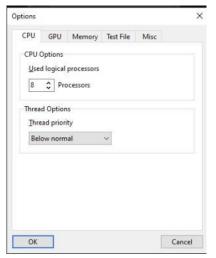
Use your processor or even a specific number of processor cores to full capacity. HeavyLoad performs complex calculations to simulate the load on your processor. 0~100%

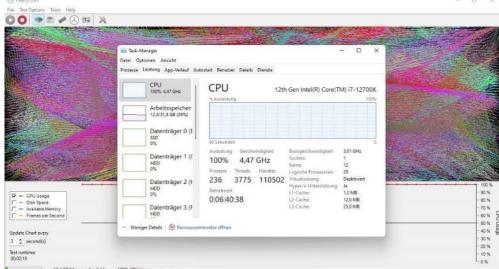
#### 

Allows to set the number of used logical processors for the CPU stress test if the system has more than one. The default number is set to the maximum amount of available processors (physical and virtual cores) on your system.

#### Thread Options Thread priority

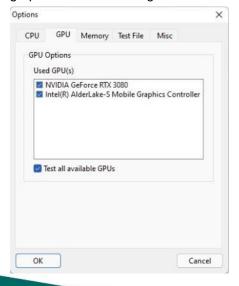
Allows to define the priority at which the threads are running. This can be used to precisely control the system utilization of HeavyLoad. "Idle" means the CPU will only be used if no other threads are using it. Choosing a higher priority will result in the stress threads having a higher priority than the thread of the user interface, which may result in the user interface being unresponsive during the tests.





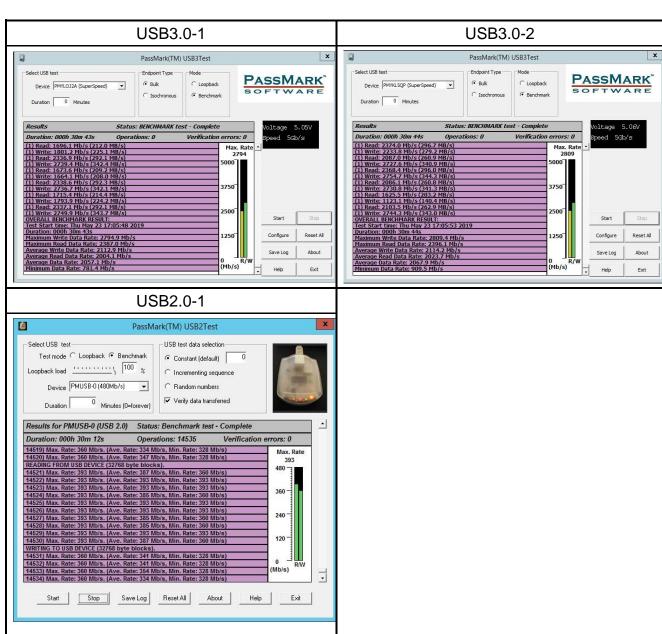
#### Stress GPU

HeavyLoad you can utilize your graphics card processor to capacity. HeavyLoad employs a 3D rendered graphic to simulate a high load on the GPU.



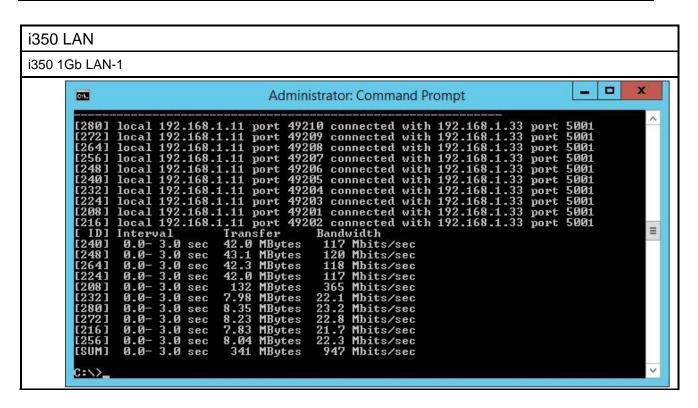
#### 4 USB PERFORMANCE

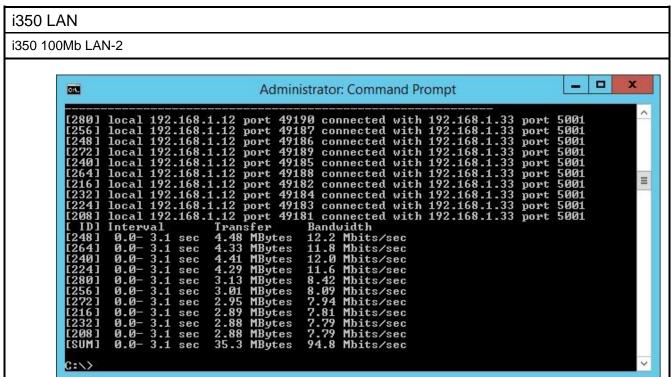
Loopback Plugs for USB 3.0 &USB2.0					
Software	Comment / (unit)	connector	Read / Write (Mb/s)	Result	Note
	PassMark USB3.0 test	USB3.0-1	2004/2112		
PassMark Software	plug	USB3.0-2	2023/2114		
Passivialik Sultwale	PassMark USB2.0 test	USB2.0-1	202/260 (Mb/s)		
	plug	USB2.0-1	393/360 (Mb/s)		



#### 5 LAN PERFORMANCE

Test Method	LAN Speed must working follow setting speed in OS.			
	i350 LAN-1 i350 LAN-2			
iperf test speed (Mbps)	947 Mb/s	94.8 Mb/s		





## 6 MIL-STD-810G ENVIRONMENTAL ENGINEERING CONSIDERATIONS AND LABORATORY TESTS

The AVR800-X1A shall be tested under the environmental conditions as defined by MIL-STD-810F and MIL-HDBK-454, as detailed in Table 1

Table 1: List of Tests

	Table 1: List of Tests				
#	Test				
		Spec' as Internal	Conditions		
		Equipment			
		MIL-STD-810G, Method 500.5 & Procedure I, Storage	Altitude not operational Storage/Air Transport The system shall not be damaged nor its performance degraded during and after exposure to environment of 15,000 feet altitude and exposed to +71°C and -33°C (absolute pressure of 55KPa),		
1	Low Pressure (Altitude)	MIL-STD-810G, Method 500.5 & Procedure I, Storage	Altitude not operational Storage/Ground Transport The system shall not be damaged nor its performance degraded during and after exposure to environment of -400m to 2500m altitude and exposed to +71°C and -20°C		
		MIL-STD-810G, Method 500.5 & Procedure II, Operating mode	Altitude operation ground The system shall not be damaged nor its performance degraded during and after exposure to -200÷2500[m] ground operation and exposed to +55°C and -20°C		
2	High Temperature	MIL-STD-810G, Method 501.5, Procedure I& II Storage & Operation	High Temperature Storage +71°C per MIL-STD-810G/501.5/I for 7 cycles High Temperature Operation +55°C per MIL-STD-810G/501.5/II for 3 cycles		
3	Low Temperature	MIL-STD-810G, Method 502.5, Procedure I& II Storage & Operation	Low Temperature Storage33°C for 72 hours Low Temperature operation The minimum steady operational temperature is -20°C with design goal of -33°C according to Figure 2. The system shall be in operational mode during temperature rise time (-33°C÷25°C) and should be tested at 0°C and 25°C		
4	Humidity	MIL-STD-810G, Method 507.5, Procedure II (Aggravated), Constant high Humidity – B1	exposure to 10 cycles of 95% relative humidity at temperatures of 30 °C to 60 °C.		
5	Salt Fog	MIL-STD-810G, Method 509.5	5% NaCl @35°C, 95% relative humidity24hrs of exposure followed by 24hrs Drying less than 50% relative humidity, 2 cycles		
6	Sand & Dust	MIL-STD-810G, Method 501.5	The system shall survive without any damage or degradation of performance and should operate to specification during and after exposure to blowing dust test according to MIL-STD-810G/510.5/I. Test parameters:  Dust particle size: <150µm.  Dust concentration: 10.6 gr/m3  Wind speed: 8.9 m/s.		
7	Immersion	Method 512.5	The system shall survive without any damage or degradation of performance and should operate to specification after exposure to sealing test according to IEC 60529/ IP65.		

#	Test					
		Spec' as Internal Equipment	Conditions			
8	Vibrations	MIL-STD-810G/514.6	Packaged components by commercial aircraft Test duration: 20 minutes per axis (x,y,z) to simulate 20 landings and takeoffs. This test shall be performed using reusable dedicated ruggedized package for spare parts.  C-130(J/K) aircraft Test duration 400 minutes per axis (x,y,z), simulating 120 flight hours including 20 landings and takeoffs.  Sine Tones (Dwell)  Sine Tones (Dwel			

#	Test				
		Spec' as Internal Equipment	Conditions		
9	Vibrations	MIL-STD-810G/514.6	Functional Vibration Test duration: completion of functional test. Coordinate system according to Figure 1.    Auto X Eventional Vibration   Section   Se		
10	Shock	MIL-STD-810G, Method 516.6	Road Transportation Test parameters:  Axis G peak [g] Duration [ms] Pulse Amount XYZ 10 11 Sawtooth 3 in each direction  Transit Drop (Packaged Components) All components shall survive without any damage or degradation of performance and should operate to specification after exposure to transit drops experienced during logistic transportation according to MIL-STD 810G CH1 method 516.6 procedure IV table 516.7-VII. This test shall be performed using reusable dedicated ruggedized package for spare parts.  Bench Handling Large components shall survive without any damage or degradation of performance and should operate to specification after exposure to bench handling shocks according to MIL-STD 810G method 516.6/ VI.		

#### 6-1 LOW PRESSURE (ALTITUDE) TEST

#### 6-1-1 Requirements

Perform the Low Pressure (Altitude) test in accordance with MIL-STD-810G Method 500.5 Procedures I with the following parameters:

#### Storage (Air-Transport)

	-33°C to +71°C	<b>O</b> Altitude	15000 feet
C Pressure	55Kpa	€	

Pressure	ээпра		
Storage (Ground-Tra	nsport)		
Range	-20°C to +71°C	O Ground	-400+2500[m]
Operation Ground			
	-20°C to +55°C	<b>○</b> Ground	-200+2500[m]

#### 6-1-2 Test Procedure – Storage (Non-Operating)

- Step 1. At ambient condition perform a visual and functional test per [Subject]
- Step 2. Document the results.
- Step 3. Insert the AVR800-X1A in the test facility.
- Step 4. Prepare the AVR800-X1A in its storage configuration.
- Step 5. At completion of the test adjust the chamber air temperature to ambient conditions until temperature stabilization of the AVR800-X1A.
- Step 6. Document the results.

#### 6-1-3 Test Procedure – Operating

- Step 1. At ambient condition perform a visual and functional test per [Subject]
- Step 2. Document the results.
- Step 3. Insert the AVR800-X1A in the test facility.
- Step 4. Prepare the AVR800-X1A in its storage configuration.
- Step 5. At completion of the test adjust the chamber air temperature to ambient conditions until temperature stabilization of the AVR800-X1A.
- Step 6. Document the results.

#### 6-2 HIGH TEMPERATURE TEST

#### 6-2-1 Requirements

Perform the high temperature test in accordance with MIL-STD-810G Method 501.5 Procedures I & II with the following parameters:

#### **Storage (Non-Operating)**

Temperature +33°C to +71°C		©Cycle Duration 24 hrs.	
Cycles	7	ltem condition	Unpacked
Operation:  Temperature			
a Temperature Range	+33°C to +55°C	O Cycle Duration	24 hrs.
Cycles	3	★ Item condition	Unpacked

#### 6-2-2 Test Procedure – Storage (Non-Operating)

- Step 1. At ambient condition perform a visual and functional test per [Subject]
- Step 2. Document the results.
- Step 3. Insert the AVR800-X1A in the test facility.
- Step 4. Prepare the AVR800-X1A in its storage configuration.
- Step 5. Expose the AVR800-X1A to 7 cycles (duration of 24 hours each cycle) of storage high temperature as described.
- Step 6. At completion of the test adjust the chamber air temperature to ambient conditions until temperature stabilization of the AVR800-X1A.
- Step 7. Perform a visual and functional test per [Subject].
- Step 8. Document the results.

Table 2: Storage High Temperature One Cycle Profile

Temp [°C]	Time of day
35	01:00
34	02:00
34	03:00
33	04:00
33	05:00
33	06:00
36	07:00
40	08:00
44	09:00
51	10:00

56	11:00
63	12:00
69	13:00
70	14:00
71	15:00
70	16:00
67	17:00
63	18:00
55	19:00
48	20:00
41	21:00
39	22:00
37	23:00
35	24:00

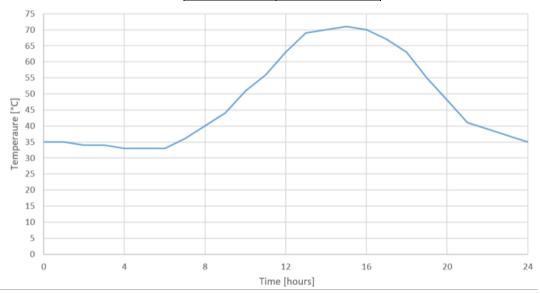


Figure 1: Storage High Temperature One Cycle Profile

#### 6-2-3 Test Procedure - Operating

- Step 1. At ambient condition perform a visual and functional test per [Subject]
- Step 2. Document the results.
- Step 3. Insert the AVR800-X1A in the test facility.
- Step 4. Prepare the AVR800-X1A in its operational configuration.
- Step 5. Locate thermocouples on the AVR800-X1A.
- Step 6. Turn ON the AVR800-X1A.
- Step 7. Expose the AVR800-X1A to 3 cycles (duration of 24 hours each cycle) of operation high temperature as describe in Table 3.
- Step 8. At the maximum temperature of each one of the 3 cycles, perform functional test per [Subject] as shown.錯誤! 找不到參照來源。
- Step 9. Document the results.
- Step 10. At completion of the test switch OFF the AV800-X1A.
- Step 11. Adjust the chamber air temperature to ambient conditions until temperature stabilization of the AVR800-X1A.
- Step 12. Perform a visual and functional test per [Subject]
- Step 13. Document the results

Table 3: Operation High Temperature One Cycle Profile

Temp [°C]	Time of day
35	1.00
34	2.00
34	3.00
33	4.00
33	5.00
32	6.00
33	7.00
35	8.00
38	9.00
41	10.00
43	11.00
44	12.00
47	13.00
50	14.00
52	15.00
55	16.00
48	17.00
48	18.00

46	19.00
42	20.00
41	21.00
39	22.00
38	23.00
37	24.00

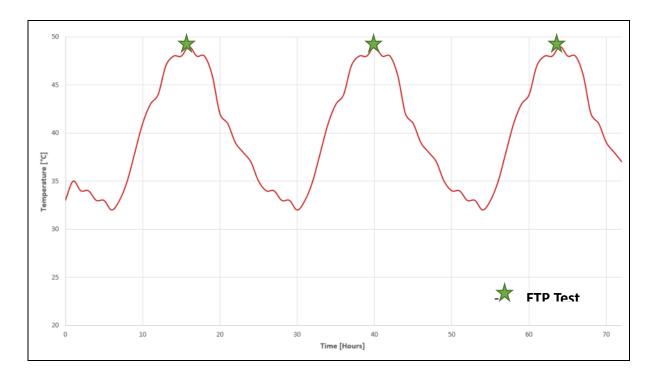


Figure 2: Operation High Temperature Test Profile

#### 6-2-4 Acceptance Criteria

#### Storage:

Visual- No evidence of damage shell be seen.

Functional -No degradation of performance.

#### **Operation**:

Visual- No evidence of damage shell be seen.

Functional -No degradation of performance during exposure to high temperature.

#### 6-3 LOW TEMPERATURE TEST

#### 6-3-1 Requirements

Perform the low temperature test in accordance with MIL-STD-810G Method 502.5 Procedures I & II with the following parameters:

<b>A</b>	Temperatur e	Storage: -33°C Oper ation -20°C	0	Duration	Opera	urs after stabilization
•	Item condi tion	Unpacked	>	Max. Change Rate	2	°C/min

#### 6-3-2 Test Procedure

- Step 1.At ambient condition perform a visual and functional test per [Subject]
- Step 2.Document the results.
- Step 3.Insert the AVR800-X1A in the test facility.
- Step 4.Prepare the AVR800-X1A in its operation configuration.
- Step 5.Locate thermocouples on the AVR800-X1A.
- Step 6. With the AVR800-X1A not operating adjust the chamber temperature to -33°C with temperature change rate not exceed of 3°C/min.
- Step 7.After AVR800-X1A stabilization maintain the chamber temperature at -33°C for dwell duration of 72 hours.
- Step 8.After 4 hours dwell operate the AVR800-X1A maintain the condition for 2 hours dwell duration.
- Step 9.Perform a functional test per [Subject]. Document the results.
- Step 10.At completion of the test switch OFF the AVR800-X1A.
- Step 11.Adjust the chamber air temperature to ambient conditions until temperature stabilization of the AVR800-X1A with temperature change rate not exceed of 3°C/min.
- Step 12.Perform visual and functional tests per [Subject]
- Step 13. Document the results

#### **3.1.2.3.2.** Low Temperature operation

The system shall survive without any damage or degradation of performance during and after exposure to low temperature per MIL-STD-810G/502.5/II.

The minimum steady operational temperature is -20°C with design goal of -33°C according to Figure 2. The system shall be in operational mode during temperature rise time (-33°C÷25°C) and should be tested at 0°C and 25°C

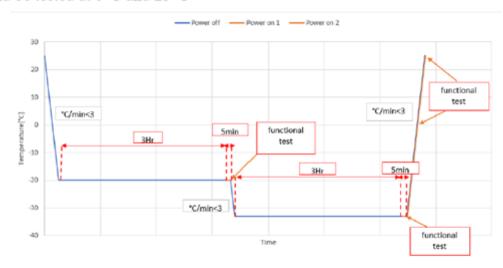


Figure 2: Low Temperature Operational Cycle

#### 6-3-3 Acceptance Criteria

Visual- No evidence of damage shell be seen.

#### 6-4 HUMIDITY TEST

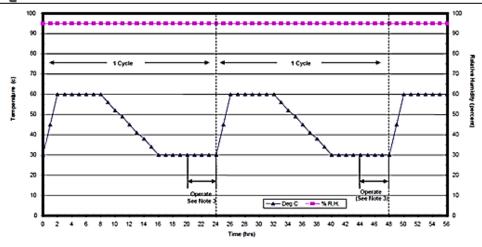
#### 6-4-1 Requirements

Perform the humidity test in accordance with MIL-STD-810G Method 507.5Procedure II Aggravated cycle with the following parameters:

	Unpacked			
O Cycle Duration	24 hours	Cycles	10	
Range	+30°C to +60°C	Humidity	95±5%KП	
Temperature	120°C to 160°C	<b>♦</b> Humidity	05 . 50/ DLI	

#### 6-4-2 Test Procedure

- Step 1. At ambient condition perform a visual and functional test per [Subject]
- Step 2. Document the results.
- Step 3. Insert the AVR800-X1A in the test facility.
- Step 4. Prepare the AVR800-X1A in its operation configuration.
- Step 5. With the AVR800-X1A not operating adjust the chamber temperature with relative humidity of 50±5 %RH, duration of 24 hours.
- Step 6. Adjust the chamber relative humidity to minimum 95%RH, maintain this condition thru the next steps below (steps 7-13).
- Step 7. Reduce the chamber temperature to +30°C.
- Step 8. With duration of 2 hours reduce the chamber temperature to +60°.
- Step 9. Maintain the chamber temperature at+60°C for additional 6 hours.
- Step 10. With duration of 8 hours decrease the chamber temperature to +30°C.
- Step 11. Maintain the chamber temperature at+30°C for additional 8 hours.
- Step 12. Repeat steps 8 thru 11 for a total of 10 cycles.
- Step 13. During the end of the fifth and ten cycles operate the SR800 and perform a functional test per [Subject]
- Step 14. Adjust the chamber air temperature to ambient conditions until temperature stabilization of the AVR800-X1A.
- Step 15. Perform a visual and functional test per [Subject].
- Step 16. Document the results.



Aggravated temperature-humidity cycle.

#### NOTES:

- Maintain the relative humidity at 95 ±4 percent at all times except that during the descending temperature periods the relative humidity may drop to as low as 85 percent.
- 2. A cycle is 24 hours.
- 3. Perform operational checks near the end of the fifth and tenth cycles.

Time	Temp.		RH
	°C	°F	Percent
0000	30	86	
0200	60	140	+
0800	60	140	Constant at 95 percent
1600	30	86	bel
2400	30	86	t 95
0200	60	140	nt a
0800	60	140	nsta
1600	30	86	ဝိ
2400	30	86	

Figure 3: Humidity Test Profile

#### 6-4-3 Acceptance Criteria

Visual- No evidence of damage and corrosion shell be seen.

#### 6-5 SALT FOG TEST

#### 6-5-1 Requirements

Perform the salt fog test in accordance with MIL-STD-Method 509.5 with the following parameters:

tem Condition	Unpacked Non-Operational	Salt Solution Concentration	5±1%
Salt Fog PH	6.5 to 7.2	Salt Fog Fallout Rate	1-3 ml/80cm²/h
<b>Humidity Condition</b>	95%	Temperature	35°C

#### 6-5-2 Test Procedure

- Step 1. At ambient condition perform a visual and functional test per [Subject]
- Step 2. Document the results.
- Step 3. Install the AVR800X1A (mechanical mockup unit is allowed) in the salt fog test chamber with all cables connected. Connector caps may be used instead of the cables.
- Step 4. Adjust the test chamber temperature to +35°C±2°C and condition the AVR800-X1A for at least two hours before introducing the salt fog.
- Step 5. Expose the AVR800-X1A to a 5%±1% concentration of salt spray at a temperature of +35°C±2°C for a period of 24 hours.
- Step 6. Remove the AVR800-X1A from the test chamber and allow it to dry at standard ambient atmosphere for 24 hours. Minimize handling the AV800-X1A during the drying period.
- Step 7. Repeat Steps 3 to 6 once again.
- Step 8. Perform a visual and functional test [Subject]
- Step 9. Document the results.

#### 6-5-3 Acceptance Criteria

Visual- No evidence of damage and corrosion shell be seen.

#### 6-6 SAND & DUST TEST

#### 6-6-1 Requirements

Perform the Sand & Dust test in accordance with MIL-STD-Method 510.5 with the following parameters:

Dust particle	< 150um.	ď	Dust Concentration	10.6 gr/m3
<b>○</b> Wind Speed	8.9 m/s			

#### 6-6-2 Test Procedure

- Step 1. Step 1. At ambient condition perform a visual and functional test per [Subject]
- Step 2. Step 2. Document the results.
- Step 3. Step 3. Insert the AVR800-X1A in the test facility.
- Step 4. Step4. Prepare the AVR800-X1A in its operation configuration.
- Step 5. Step 5. Blowing dust at 25oC for 6 hours , and an additional 6 hours at 49oC (Climatic Category A1)
- Step 6. Step 6. Perform a visual and functional test [Subject]
- Step 7. Step 7. Document the results

#### 6-6-3 Acceptance Criteria

Visual- No evidence of damage and corrosion shell be seen.

#### **IMMERSION TEST**

#### 6-7-1 Requirements

Perform the blowing rain test in accordance MIL-STD-810G Method 512.5 Procedure I with the following parameters:

Perform the

test according I Water Depth:

to IP65

tem condition

Unpacked

Non-Operation

requirements.

O Duration

2 min

#### 6-7-2 Test Procedure

- Step 1. At ambient condition conduct a complete visual examination of the test item with special attention to sealed areas, gaskets/seals, and structural integrity, and document the results. Take photographs, if appropriate. Verify that no free water is present; if so, dry.
- At ambient condition perform functional test per [Subject] Step 2.
- Step 3. Weigh the AVR800-X1A.
- Step 4. Document the results.
- Step 5. Three times immediately before the test, open and close (or remove and replace) any doors, covers, etc., that would be opened during normal use to ensure any seals are functioning properly and are not adhering to the sealing (mating) surfaces.
- Ensure temperature differential between the water and the AVR800-X1A of Step 6. more than 10°C.
- Step 7. Record the water temperature and the AVR800-X1A temperature.
- Step 8. Close all sealed areas and valves.
- Step 9. The spraying with a hose on test item in water the surface of the water for duration of 3 minutes.
- Remove AVR800-X1A from the water, wipe the exterior surfaces dry (giving Step 10. special attention to areas around seals and relief valves), be careful to not allow water to enter the test item while activating the manual valves.
- Step 11. Weigh the AVR800-X1A.
- Step 12. Open the AVR800-X1A and examine the interior and contents for evidence of and quantity of any leakage and, if leakage occurred, for probable areas of
- Step 13. Perform functional test per [Subject]
- Document the results. Step 14.

#### 6-7-3 Acceptance Criteria

No evidence of water penetration shell be seen inside the AVR800-X1A. No evidence of damage shell be seen.

Functional

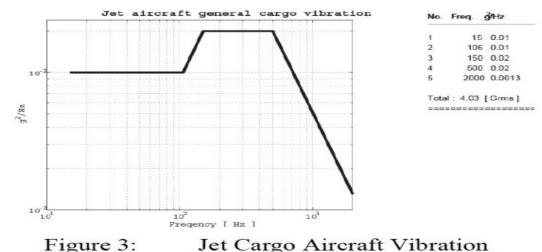
No degradation of performance.

#### 6-8-1 Requirements

Perform the vibration test in accordance with MIL-STD-810G Method 514.6 category 7. Packaged components by commercial aircraft that it is non-operational in reusable ruggedized packaging -- with the following parameters:

#### 6-8-2 Test Procedure

Test duration: 20 minutes per axis (x,y,z) to simulate 20 landings and takeoffs.



6-8-3 Requirements

Jet Cargo Aircraft Vibration

Perform the vibration test in accordance with MIL-STD-810G Method 514.6 category 7. C-130(J/K) aircraft unpacked and in non-operating mode -- with the following parameters:

#### 6-8-4 Test Procedure

Test duration 400 minutes per axis (x,y,z), simulating 120 flight hours including 20 landings and takeoffs.

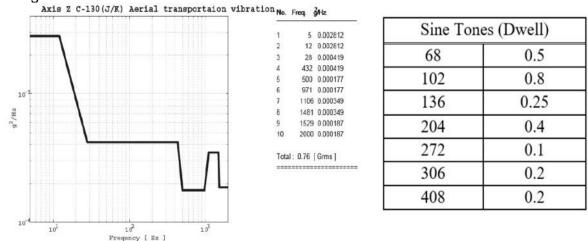


Figure 4: For unknown orientation axis- C-130(J\K) Aerial Transportation Vibration

#### 6-8-5 Requirements

Perform the vibration test in accordance with MIL-STD-810G Method 514.8 category 4. Ground Transportation (Packaged) – Common Carrier -- with the following parameters:

#### 6-8-6 Test Procedure

Test duration: 190 minutes per axis to simulate 5000 km of driving distance. This test shall be performed using reusable dedicated ruggedized package for spare parts.

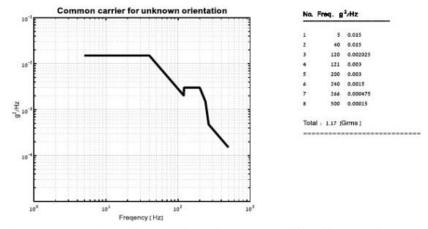


Figure 5: Common Carrier Vibration Profile for unknown orientation

#### 6-8-7 Requirements

Perform the vibration test in accordance with MIL-STD-810G Method 514.6 category 7. Tactical Transportation – Not Operational – with the following parameters:

#### 6-8-8 Test Procedure

Test duration: 100 minutes per axis to simulate 500,000 km driving distance. Coordinate system according to Figure 1.

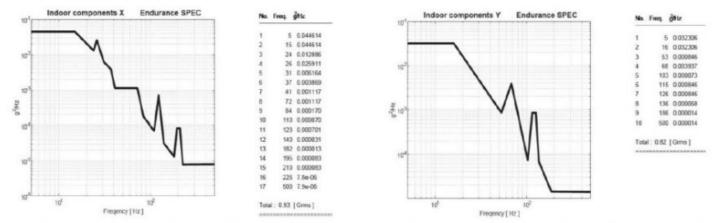


Figure 6: Axis X Tactical Transportation Vibration

Figure 7: Axis Y Tactical Transportation Vibration

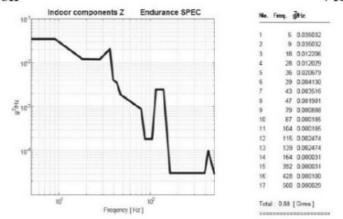


Figure 8: Axis Z Tactical Transportation Vibration

### 6-8-9 Requirements

Perform the vibration test in accordance with MIL-STD-810G Method 514.6 category 7. Functional Vibration— with the following parameters:

#### 6-8-10 Test Procedure

Test duration: completion of functional test. Coordinate system according to Figure 1.

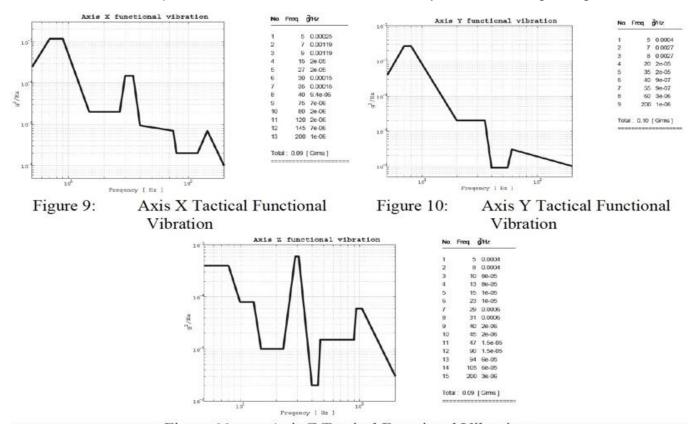


Figure 11: Axis Z Tactical Functional Vibration

#### 6-8-11 Acceptance Criteria

Visual- No evidence of damage and corrosion shell be seen.

#### 6-9 SHOCK TEST

#### 6-9-1 Requirements

Perform the Shock test in accordance with MIL-STD-810G Method 516.6. Road Transportation -- with the following parameters:

#### 6-9-2 Test Procedure

Test parameters:

Axis	G peak [g] Duration [ms]		Pulse	Amount		
XYZ	10 11		Sawtooth	3 in each direction (±)		

### 6-9-3 Acceptance Criteria

Visual- No evidence of damage and corrosion shell be seen.

#### 6-10 TRANSIT DROP TEST

#### 6-10-1 Requirements

Perform the transit drop test in accordance with MIL-STD-810G Method 516.6 Procedure IV with the following parameters:

Ttem Condition	Packed	<sup></sup>	122 cm
<sup>1</sup> Total Drops	26	☐t Impact Surface	Wood

#### 6-10-2 Test Procedure

- Step 1. At ambient condition perform a visual and functional test per [Subject]
- Step 2. Document the results.
- Step 3. Install the AVR800-X1A in its transit case.
- Step 4. Adjust the drop facility to height of 122 cm.
- Step 5. Assemble the AVR800-X1A on the drop facility.
- Step 6. Preform 26 drops one drop on each face, edge and corner.
- Step 7. At completion of the test perform a visual and functional test per [Subject]
- Step 8. Document the results.

### 6-10-3 Acceptance Criteria

Visual- No evidence of damage shell be seen.

#### 6-11 BENCH HANDLING TEST

#### 6-11-1 Requirements

Perform the bench handling test in accordance with MIL-STD-810G Method 516.6 Procedure VI with the following parameters:

Height	100mm / 45°	☐t Impact Surface	Solid Wood
tem condition	Unpacked – Non-Operation	<sup>1</sup> Total Drops	12

#### 6-11-2 Test Procedure

- Step 1. At ambient condition perform a visual and functional test per [Subject]
- Step 2. Document the results.
- Step 3. Configure the item as it would be for servicing on the base face.
- Step 4. Using one edge as a pivot, lift the opposite edge of the chassis until one of the following conditions occur (whichever occurs first).
- Step 5. The chassis forms an angle of 45° with the horizontal bench top.
- Step 6. The lifted edge of the chassis has been raised 10 cm above the horizontal bench top.
- Step 7. The lifted edge of the chassis is just below the point of perfect balance.
- Step 8. Let the chassis drop back freely to the horizontal bench top. Repeat, using other practical edges of the same horizontal face as pivot points, for a total of four drops.
- Step 9. Repeat step 2 thru step 3 with the AVR800-X1A resting on 2 other side faces (Flat faces, without connectors) until it has been dropped for a total of four times on each face. The AVR800-X1A shall not be operating.
- Step 10. Perform a visual and functional test per [Subject]
- **Step 11.** Document the results.

#### 6-11-3 Acceptance Criteria

Visual- No evidence of damage shell be seen.

# 7 MIL-STD-461F EQUIREMENTS FOR THE CONTROL OF ELECTROMAGNETIC INTERFERENCE CHARACTERISTICS OF SUBSYSTEMS AND EQUIPMENT

The AVR800-X1A shall be tested under the ELECTROMAGNETIC INTERFERENCE CHARACTERISTICS as defined by MIL-STD-461F, as detailed in Table 1

Table 4: List of Tests

#	Test					
		Spec' as Equipment Conditions				
1	CE102	Conducted emissions, power leads, 10KHz to 10MHz				
2	CS101	CS101 Conducted susceptibility, power leads, 30Hz to 150KHz				
3	CS114	Conducted susceptibility, bulk cable injection, 10KHz to 200MHz, curves 3&4				
4	CS115	Conducted susceptibility, bulk cable injection, impulse excitation				
5	5 CS116 Conducted susceptibility, damped sinusoidal transients, cables and power 10KHz to 100MHz					
6	RE102	Radiated emissions, electric filed, 10KHz to 18GHz				
7	RS103	Radiated susceptibility, electric filed, 2Mhz to 18GHz, 50V/m				

**7-1 RE102 TESTRequirements**Perform the Radiated emissions, electric filed test in accordance with MIL-STD-461F the following parameters:**10KHz to 18GHz** 

#### 7-1-2 Test Procedure

### <u>Limit</u>

Electric field emissions shall not be radiated in excess of those shown in Figures RE102-1 through RE102-4. Above 30 MHz, the limits shall be met for both horizontally and vertically polarized fields.

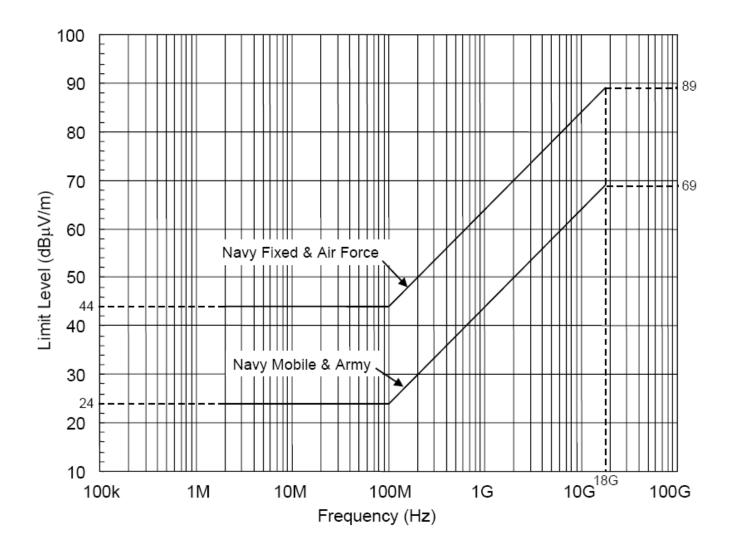
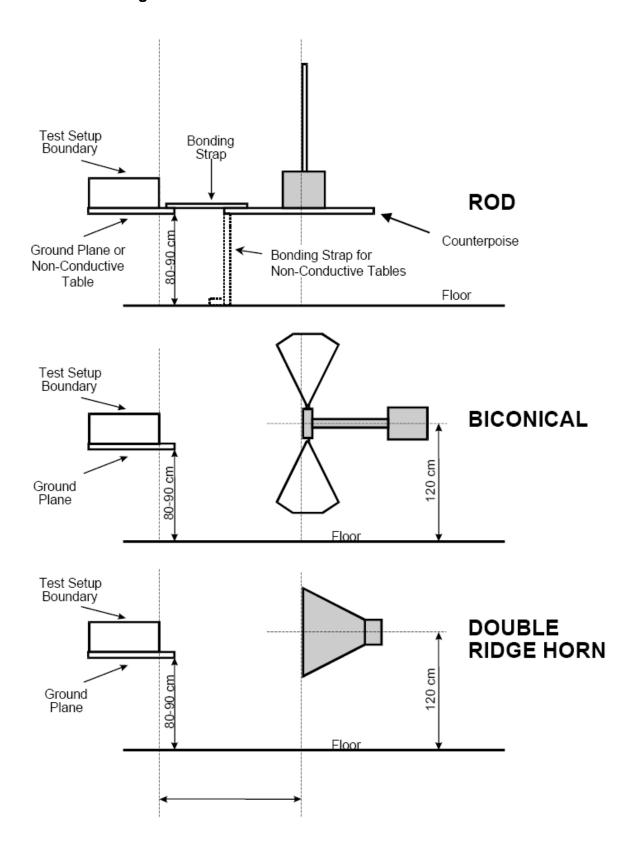
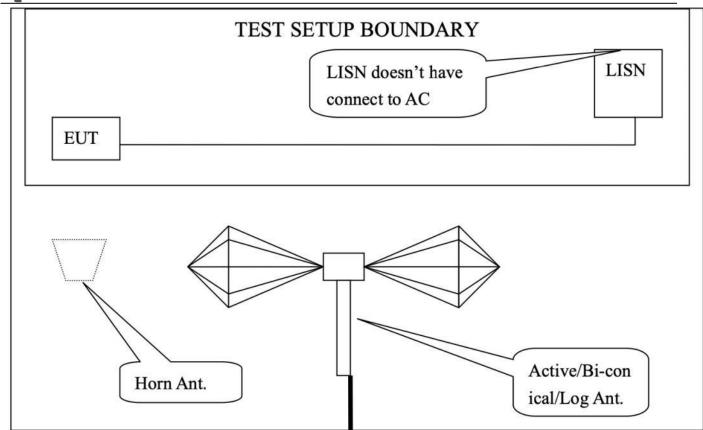


FIGURE RE102-4. RE102 limit for ground applications.

### 7-1-3 Test Configuration





#### 7-2 CE102 TEST

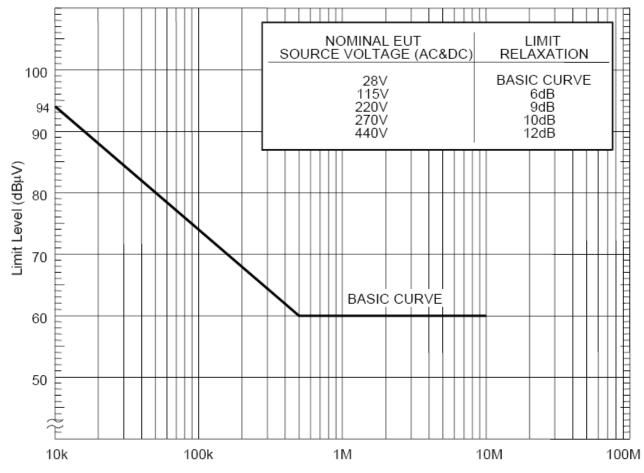
### 7-2-1 Requirements

Perform the Conducted emissions, power leads test in accordance with MIL-STD-461F the following parameters:10KHz to 10MHz

#### 7-2-2 Test Procedure

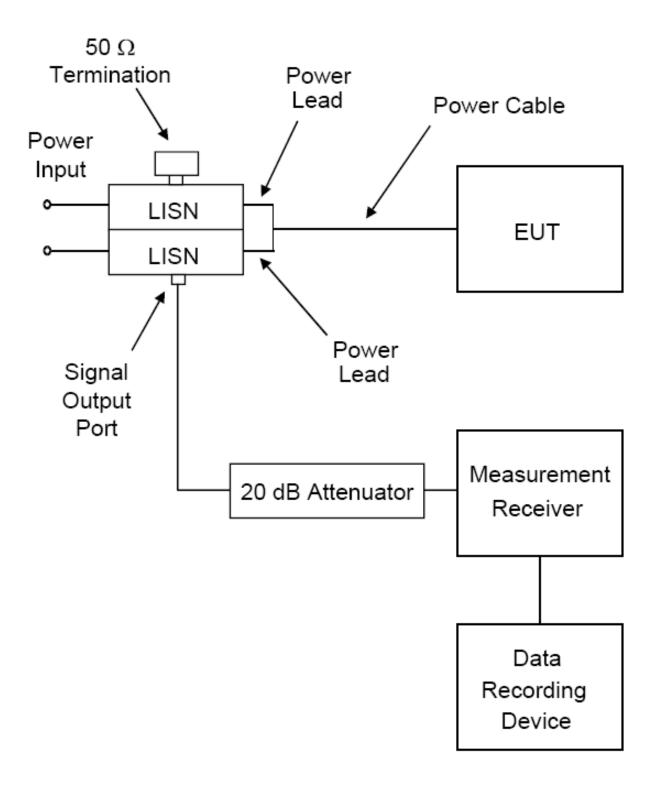
Conducted emissions on power leads shall not exceed the applicable values shown on Figure

CE102-1.



The magnetic emission of EUT representative of its type shall be tested by the method(s) according to MIL STD 461E/F.

### 7-2-3 Test Configuration



Conducted emissions on power leads shall not exceed the applicable values shown on Figure CE102-1.

#### 7-3 CS101 TEST

### 7-3-1 Requirements

Perform the Conducted susceptibility, power leads test in accordance with MIL-STD-461F the following parameters:30Hz to 150KHz

#### 7-3-2 Test Procedure

### Limit

The EUT shall not exhibit any malfunction, degradation of performance, or deviation from specified indications, beyond the tolerances indicated in the individual equipment or subsystem

specification, when subjected to a test signal with voltage levels as specified in Figure CS101-1.

The requirement is also met when the power source is adjusted to dissipate the power level

shown in Figure CS101-2 in a 0.5 ohm load and the EUT is not susceptible.

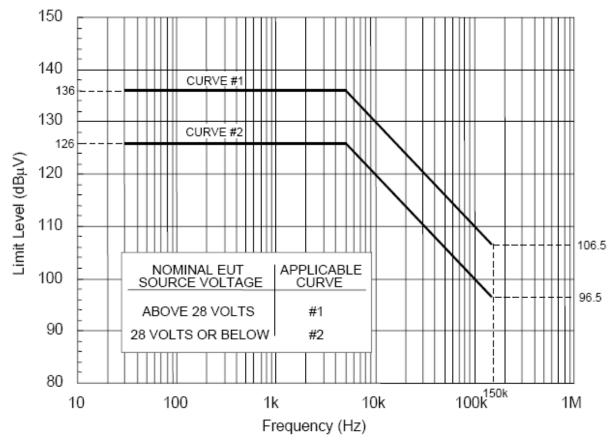


FIGURE CS101-1. CS101 voltage limit for all applications.

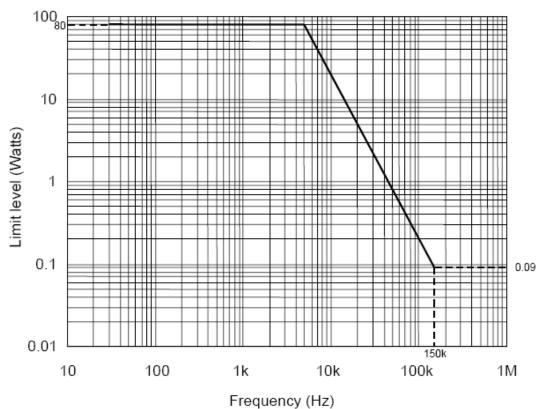


FIGURE CS101-2. CS101 power limit for all applications.

### **Classification Of Functional Status**

All classifications are for the total device/system functional status.

**Class A:** all functions of a device/system perform as designed during and after exposure to

disturbance.

**Class B:** all functions of a device/system perform as designed during exposure. However, one or

more of them can go beyond specified tolerance. All functions return automatically to within normal limits after exposure is removed.

**Class C:** one or more functions of a device/system do not perform as designed during exposure

but return automatically to normal operation after exposure is removed.

**Class D:** one or more functions of a device/system do not perform as designed during exposure

and do not return to normal operation until exposure is removed and the device/system is reset by simple "operator/use" action.

**Class E:** one or more functions of a device/system do not perform as designed during and after

exposure and cannot be returned to proper operation without repairing or replacing the device/system.

### 7-3-3 Test Configuration

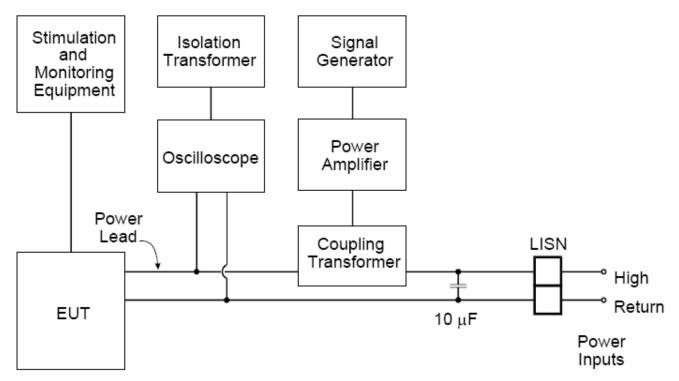


FIGURE CS101-4. Signal injection, DC or single phase AC

#### 7-4 CS114 TEST

### 7-4-1 Requirements

Perform the Conducted susceptibility, bulk cable injection test in accordance with MIL-STD-461F the following parameters: **10KHz to 200MHz, curves 3&4** 

### Limit

The EUT shall not exhibit any malfunction, degradation of performance, or deviation from specified indications, beyond the tolerances indicated in the individual equipment or subsystem

specification, when subjected to a test signal with voltage levels as specified in Figure CS114.

The requirement is also met when the power source is adjusted to dissipate the power level

shown in Figure CS114 and the EUT is not susceptible.

#### 7-4-2 Test Procedure

The CS114 test is used to verify the ability of the EUT to withstand RF signals coupled onto EUT associated cabling

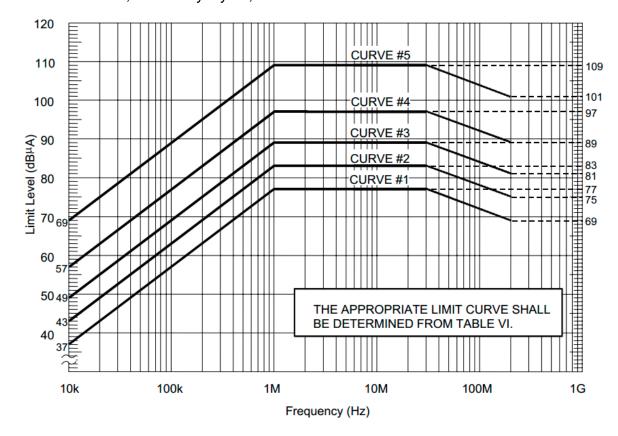
Frequency Range: 10KHz(4 KHz) - 200MHz

Dwell Time: The grater of 3 seconds or EUT response time per frequency

Frequency Step: max 5% (4KHz-1MHz), max 1% (1MHz-30MHz), max 0.1%

(30MHz-200MHz)
Unit: Current (dBuA)

Modulation: 1KHz, 50% Duty Cycle, Pulse Modulation



### **Classification Of Functional Status**

All classifications are for the total device/system functional status.

Class A: all functions of a device/system perform as designed during and after exposure to

disturbance.

**Class B:** all functions of a device/system perform as designed during exposure. However, one or

more of them can go beyond specified tolerance. All functions return automatically to

within normal limits after exposure is removed.

Class C: one or more functions of a device/system do not perform as designed during

**Class C:** one or more functions of a device/system do not perform as designed during exposure

but return automatically to normal operation after exposure is removed.

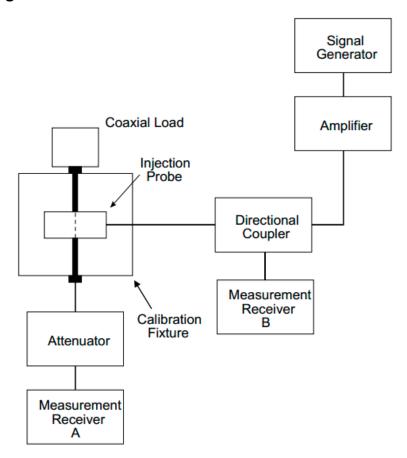
Class D: one or more functions of a device/system do not perform as designed during exposure

and do not return to normal operation until exposure is removed and the device/system is reset by simple "operator/use" action.

Class E: one or more functions of a device/system do not perform as designed during and after

exposure and cannot be returned to proper operation without repairing or replacing the device/system.

### 7-4-3 Test Configuration



#### 7-5 CS115 TEST

#### 7-5-1 Requirements

Perform the Conducted susceptibility, bulk cable injection test in accordance with MIL-STD-461F the following parameters:**impulse excitation** 

### Limit

The EUT shall not exhibit any malfunction, degradation of performance, or deviation from specified indications, beyond the tolerances indicated in the individual equipment or subsystem

specification, when subjected to a test signal with voltage levels as specified in Figure CS115.

The requirement is also met when the power source is adjusted to dissipate the power level

shown in Figure CS115 and the EUT is not susceptible.

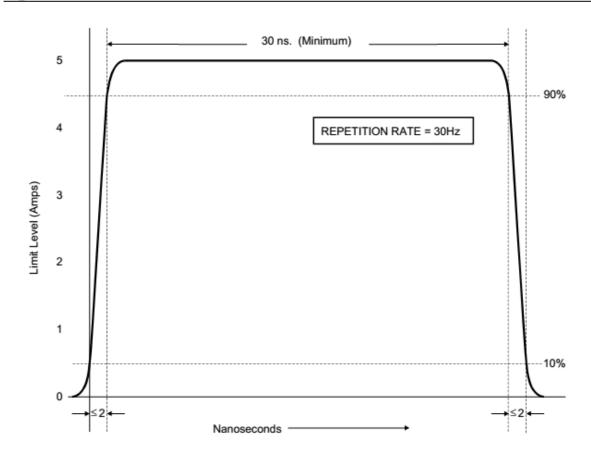
#### 7-5-2 Test Procedure

The CS115 test is used to verify the ability of the EUT to withstand impulse signals coupled onto EUT associated cabling

Frequency Range: Broadband

Unit: Current (A)Signal: Impulse

Test duration: 1 minute per application



#### **Classification Of Functional Status**

All classifications are for the total device/system functional status.

Class A: all functions of a device/system perform as designed during and after exposure to

disturbance.

**Class B**: all functions of a device/system perform as designed during exposure. However, one or

more of them can go beyond specified tolerance. All functions return automatically to within normal limits after exposure is removed.

**Class C**: one or more functions of a device/system do not perform as designed during exposure

but return automatically to normal operation after exposure is removed.

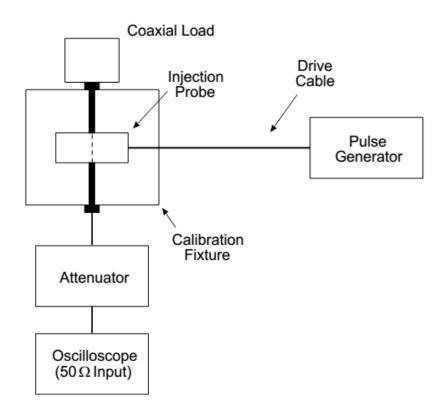
**Class D**: one or more functions of a device/system do not perform as designed during exposure

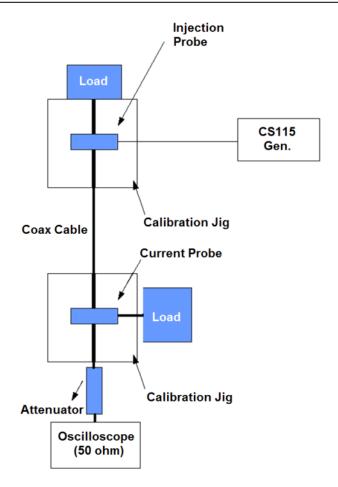
and do not return to normal operation until exposure is removed and the device/system is reset by simple "operator/use" action.

**Class E**: one or more functions of a device/system do not perform as designed during and after

exposure and cannot be returned to proper operation without repairing or replacing the device/system.

### 7-5-3 Test Configuration





#### 7-6 CS116 TEST

### 7-6-1 Requirements

Perform the Conducted susceptibility, damped sinusoidal transients, cables and power leads test in accordance with MIL-STD-461F the following parameters:10KHz to 100MHz

### Limit

The EUT shall not exhibit any malfunction, degradation of performance, or deviation from specified indications, beyond the tolerances indicated in the individual equipment or subsystem

specification, when subjected to a test signal with voltage levels as specified in Figure CS116.

The requirement is also met when the power source is adjusted to dissipate the power level

shown in Figure CS116 and the EUT is not susceptible.

#### 7-6-2 Test Procedure

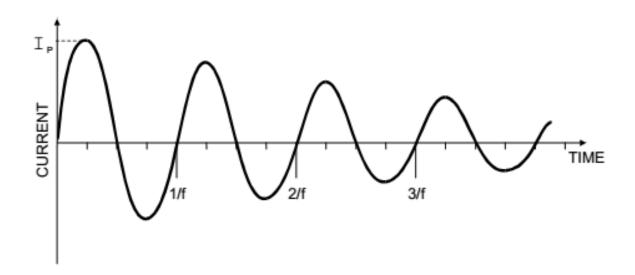
The CS116 test is used to verify the ability of the EUT to withstand damped sinusoidal transients coupled onto EUT associated cables and power leads.

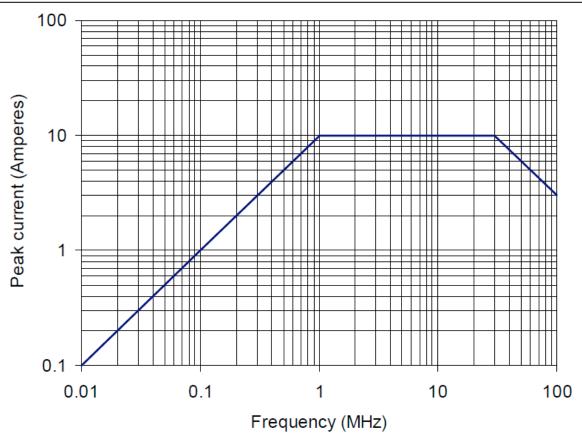
Frequency Range: 10KHz-100MHz

Unit: Current (A)

Interference Signal: Damped Sinusoidal Transients

Test Duration: 5 minutes per application





Test Frequencies: 10 kHz, 100 kHz, 1 MHz, 10 MHz, 30 MHz, 100 MHz as a minimum

### **Classification Of Functional Status**

All classifications are for the total device/system functional status.

Class A: all functions of a device/system perform as designed during and after exposure to

disturbance.

**Class B:** all functions of a device/system perform as designed during exposure. However, one or

more of them can go beyond specified tolerance. All functions return automatically to within normal limits after exposure is removed.

**Class C:** one or more functions of a device/system do not perform as designed during exposure

but return automatically to normal operation after exposure is removed.

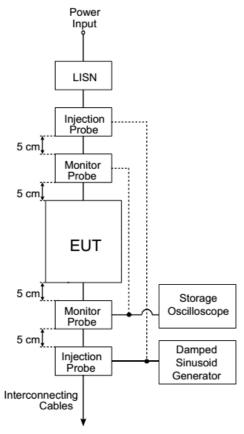
**Class D:** one or more functions of a device/system do not perform as designed during exposure

and do not return to normal operation until exposure is removed and the device/system is reset by simple "operator/use" action.

**Class E:** one or more functions of a device/system do not perform as designed during and after

exposure and cannot be returned to proper operation without repairing or replacing the device/system.

## 7-6-3 Test Configuration



Actual or Simulated Loads and Signals

Tested port	Polarity	Frequency (MHz)	Pulse Level (A)	Injected Current Level (A)
	Positive	0,01	0,1	35,3
	Positive	0,1	1	32,2
	Positive	1	10	53,3
	Positive	10	10	5,7
	Positive	30	10	6,7
Shielded Power Cable	Positive	100	3	2,1
Silleided Fower Cable	Negative	0,01	0,1	35,8
	Negative	0,1	1	32,6
	Negative	1	10	53,8
	Negative	10	10	5,8
	Negative	30	10	6,6
	Negative	100	3	2,0

#### 7-7 RS103 TEST

#### 7-7-1 Requirements

Perform the Radiated susceptibility, electric filed test in accordance with MIL-STD-461F the following parameters: **2Mhz to 18GHz**, **50V/m** 

#### 7-7-2 Test Procedure

### <u>Limit</u>

The EUT shall not exhibit any malfunction, degradation of performance, or deviation from. specified indications, beyond the tolerances indicated in the individual equipment or subsystem specification, when subjected to the radiated electric fields listed in Table VII and modulated as specified below. Up to 30 MHz, the requirement shall be met for vertically polarized fields. Above 30 MHz, the requirement shall be met for both horizontally and vertically polarized fields. Circular polarized fields are not acceptable.

	]	LIMIT LEVEL (VOLTS/METER)							
PLATFORM FREQ. RANGE		AIRCRAFT (EXTERNAL OR SAFETY CRITICAL)	AIRCRAFT INTERNAL	ALL SHIPS (ABOVE DECKS) AND SUBMARINES (EXTERNAL)*	SHIPS (METALLIC) (BELOW DECKS)	SHIPS (NON- METALLIC) (BELOW DECKS)	SUBMARINES (INTERNAL)	GROUND	SPACE
2 MHz	Α	200	200	200	10	50	5	50	20
↓	N	200	200	200	10	50	5	10	20
30 MHz	AF	200	20	,		-	•	10	20
30 MHz	A	200	200	200	10	10	10	50	20
↓	N	200	200	200	10	10	10	10	20
1 GHz	AF	200	20		-			10	20
1 GHz	A	200	200	200	10	10	10	50	20
↓	N	200	200	200	10	10	10	50	20
18 GHz	AF	200	60		-	-	-	50	20
18 GHz	A	200	200	200	10	10	10	50	20
↓	N	200	60	200	10	10	10	50	20
40 GHz	AF	200	60	-	-	-	-	50	20

\* For equipment located external to the pressure hull of a submarine but within the superstructure, use

AF = Air Force

### **Classification Of Functional Status**

All classifications are for the total device/system functional status.

**Class A:** all functions of a device/system perform as designed during and after exposure to

disturbance.

**Class B:** all functions of a device/system perform as designed during exposure.

However, one or

more of them can go beyond specified tolerance. All functions return automatically to within normal limits after exposure is removed.

**Class C:** one or more functions of a device/system do not perform as designed during exposure

KEY: A = ArmyN = Navy

SHIPS (METALLIC)(BELOW DECKS)

but return automatically to normal operation after exposure is removed.

Class D: one or more functions of a device/system do not perform as designed during exposure

and do not return to normal operation until exposure is removed and the device/system is reset by simple "operator/use" action.

Class E: one or more functions of a device/system do not perform as designed during and after

exposure and cannot be returned to proper operation without repairing or replacing the device/system.

### 7-7-3 Test Configuration

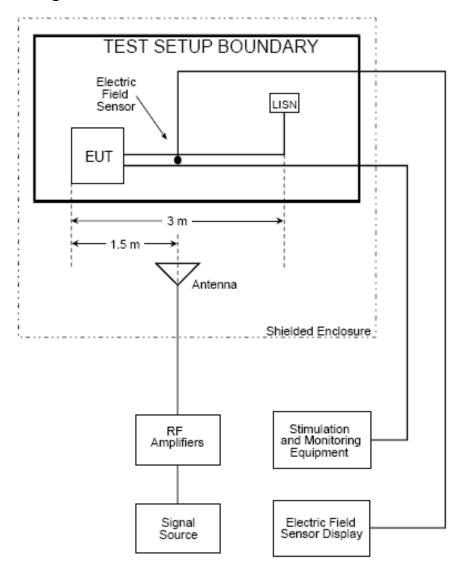


FIGURE RS103-1. Test equipment configuration.

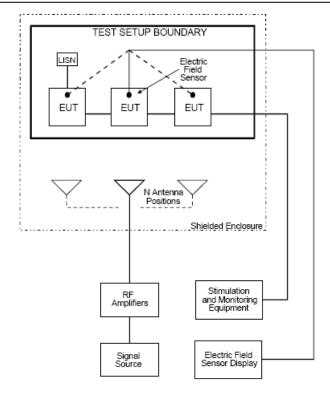


FIGURE RS103-2. Multiple test antenna locations for frequency > 200 MHz

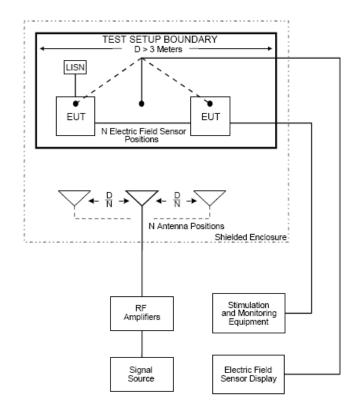


FIGURE RS103-3. Multiple test antenna locations for N positions, D > 3 meters